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To the Honorable Commissioner

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original documents or copy thereof.

1. Name of conveying parties:

Hiroyuki TSUJIKAWA
Hidenori SHIBATA
Kiyohito MUKAI

2. Name and address of receiving party(ies):

Name: MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD.

Internal Address:

Street Address: 1006, Oaza Kadoma, Kadoma City, Osaka

City: Osaka 571-0050 State: Japan Zip:

Additional name(s) & address(es) attached? Yes No

Additional name(s) of conveying party(ies) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other

Execution Date: June 25, 1999

4. Application number(s) or patent number(s): New Patent Application

If this document is being filed together with a new application, the execution date of the application is: June 25, 1999

A. Patent Application No.(s)

B. Patent No.(s)

09/348314

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: STEVENS, DAVIS, MILLER & MOSHER, L.L.P.

Internal Address: Suite 850/JEL 30749

Street Address: 1615 L Street, N.W.

City: Washington State: DC Zip: 20036

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)\$40.00

- Enclosed (Check No. 11860)
- Any deficiencies may be charged to deposit account
- Authorized to be charged to deposit account

8. Deposit account number: 19-4375

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

James E. Ledbetter
Name of Person Signing
Registration No. 28,732

Signature

July 7, 1999
Date

Total number of pages including cover sheet, attachments, and document: 2

OMB No. 0651-0011 (exp. 4/94)

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**USA
ASSIGNMENT OF PATENT APPLICATION**

(1) Hiroyuki TSUJIKAWA
 (2) Hidenori SHIBATA
 (3) Kiyohito MUKAI
 (4) _____
 (5) _____

In consideration of the sum of one dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned, the undersigned agree(s) to assign, and hereby does assign, transfer and set over to

(6) Matsushita Electric Industrial Co., Ltd.
 (6a) of 1006, Oaza Kadoma, Kadoma-shi, Osaka 571 Japan
 (7) _____
 (7a) of _____

(hereinafter designated as the Assignee) the entire rights, title and interest for the United States, its territories, dependencies and possessions, and for the country of

(8) _____ in the invention, and all applications for patent and any Letters Patent which may be granted therefor, known as
 (9) SEMICONDUCTOR DEVICE GEOMETRICAL PATTERN CORRECTION PROCESS,
 SEMICONDUCTOR DEVICE MANUFACTURING PROCESS, AND GEOMETRICAL
 PATTERN EXTRACTION PROCESS (Case No. _____)

for which the undersigned has (have) executed on even date herewith an application for patent in the United States of America or, if not on even date, then has executed

(10) on _____ or has already filed
 (11) U.S. appln. Serial No. _____, filed on _____
 (12) The undersigned acknowledges an obligation of assignment of this invention to said assignee at the time the invention was made.

- 1) The undersigned agree(s) to execute all papers necessary in connection with the application and any continuing or divisional applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.
- 2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining such evidence and going forward with such interference.
- 3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.
- 4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.
- 5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patent of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.
- 6) The undersigned hereby grant(s) the firm of STEVENS, DAVIS, MILLER & MOSHER, L.L.P. the power to insert on this assignment any further identification which may be necessary or desirable to comply with the rules of the United States Patent Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned signature(s).

Date Jun 25 1999 Signature of Inventor (1) Hiroyuki Tsujikawa (Seal)
 Date Jun 25 1999 Signature of Inventor (2) Hidenori Shibata (Seal)
 Date Jun 25 1999 Signature of Inventor (3) Kiyohito Mukai (Seal)
 Date _____ Signature of Inventor (4) _____ (Seal)
 Date _____ Signature of Inventor (5) _____ (Seal)

This assignment should preferably be signed before: (a) a Notary Public if within the U.S.A., or (b) a U.S. Counsel if outside the U.S.A. If neither, then it should be signed before at least two witnesses who also sign here:

Date June 25 1999 Signature of Witness Takao Kurita (Seal)
 Date June 25 1999 Signature of Witness Akiko Nakajima (Seal)